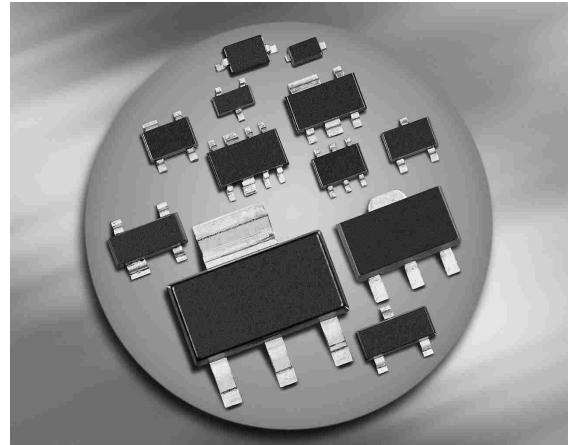


PNP Silicon AF Transistors

- For AF driver and output stages
- High collector current
- Low collector-emitter saturation voltage
- Complementary types: BCP54 ... BCP56 (NPN)
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



| Type | Marking | Pin Configuration | | | | | | Package |
|----------|---------|-------------------|-----|-----|-----|---|---|---------|
| BCP51 | * | 1=B | 2=C | 3=E | 4=C | - | - | SOT223 |
| BCP51-16 | * | 1=B | 2=C | 3=E | 4=C | - | - | SOT223 |
| BCP52-16 | * | 1=B | 2=C | 3=E | 4=C | - | - | SOT223 |
| BCP53-10 | * | 1=B | 2=C | 3=E | 4=C | - | - | SOT223 |
| BCP53-16 | * | 1=B | 2=C | 3=E | 4=C | - | - | SOT223 |

* Marking is the same as type-name

Maximum Ratings

| Parameter | Symbol | Value | Unit |
|--|-----------|-------------|------------------|
| Collector-emitter voltage BCP51 | V_{CEO} | 45 | V |
| BCP52 | | 60 | |
| BCP53 | | 80 | |
| Collector-base voltage BCP51 | V_{CBO} | 45 | |
| BCP52 | | 60 | |
| BCP53 | | 100 | |
| Emitter-base voltage | V_{EBO} | 5 | |
| Collector current | I_C | 1 | A |
| Peak collector current, $t_p \leq 10$ ms | I_{CM} | 1.5 | |
| Base current | I_B | 100 | mA |
| Peak base current | I_{BM} | 200 | |
| Total power dissipation- $T_S \leq 120^\circ\text{C}$ | P_{tot} | 2 | W |
| Junction temperature | T_j | 150 | $^\circ\text{C}$ |
| Storage temperature | T_{stg} | -65 ... 150 | |

Thermal Resistance

| Parameter | Symbol | Value | Unit |
|--|------------|-----------|------|
| Junction - soldering point ¹⁾ | R_{thJS} | ≤ 15 | K/W |

¹For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit |
|---|-----------------------------|--------|------|------|---------------|
| | | min. | typ. | max. | |
| DC Characteristics | | | | | |
| Collector-emitter breakdown voltage $I_C = 10 \text{ mA}, I_B = 0$, BCP51 | $V_{(\text{BR})\text{CEO}}$ | 45 | - | - | V |
| $I_C = 10 \text{ mA}, I_B = 0$, BCP52 | | 60 | - | - | |
| $I_C = 10 \text{ mA}, I_B = 0$, BCP53 | | 80 | - | - | |
| Collector-base breakdown voltage $I_C = 100 \mu\text{A}, I_E = 0$, BCP51 | $V_{(\text{BR})\text{CBO}}$ | 45 | - | - | |
| $I_C = 100 \mu\text{A}, I_E = 0$, BCP52 | | 60 | - | - | |
| $I_C = 100 \mu\text{A}, I_E = 0$, BCP53 | | 100 | - | - | |
| Emitter-base breakdown voltage $I_E = 10 \mu\text{A}, I_C = 0$ | $V_{(\text{BR})\text{EBO}}$ | 5 | - | - | |
| Collector-base cutoff current $V_{CB} = 30 \text{ V}, I_E = 0$ | I_{CBO} | - | - | 0.1 | μA |
| $V_{CB} = 30 \text{ V}, I_E = 0, T_A = 150^\circ\text{C}$ | | - | - | 20 | |
| DC current gain ¹⁾ $I_C = 5 \text{ mA}, V_{CE} = 2 \text{ V}$ | h_{FE} | 25 | - | - | - |
| $I_C = 150 \text{ mA}, V_{CE} = 2 \text{ V}$, BCP51 | | 40 | - | 250 | |
| $I_C = 150 \text{ mA}, V_{CE} = 2 \text{ V}$, BCP53-10 | | 63 | 100 | 160 | |
| $I_C = 150 \text{ mA}, V_{CE} = 2 \text{ V}$, BCP51-16...BCP53-16 | | 100 | 160 | 250 | |
| $I_C = 500 \text{ mA}, V_{CE} = 2 \text{ V}$ | | 25 | - | - | |
| Collector-emitter saturation voltage ¹⁾ $I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$ | V_{CEsat} | - | - | 0.5 | V |
| Base-emitter voltage ¹⁾ $I_C = 500 \text{ mA}, V_{CE} = 2 \text{ V}$ | $V_{\text{BE}(\text{ON})}$ | - | - | 1 | |

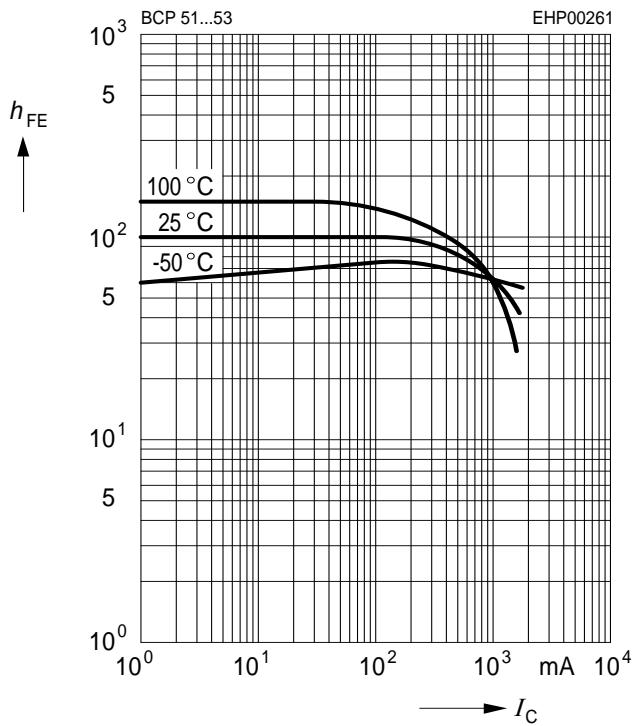
AC Characteristics

| | | | | | |
|---|-------|---|-----|---|-----|
| Transition frequency $I_C = 50 \text{ mA}, V_{CE} = 10 \text{ V}, f = 100 \text{ MHz}$ | f_T | - | 125 | - | MHz |
|---|-------|---|-----|---|-----|

¹⁾Pulse test: $t < 300\mu\text{s}$; $D < 2\%$

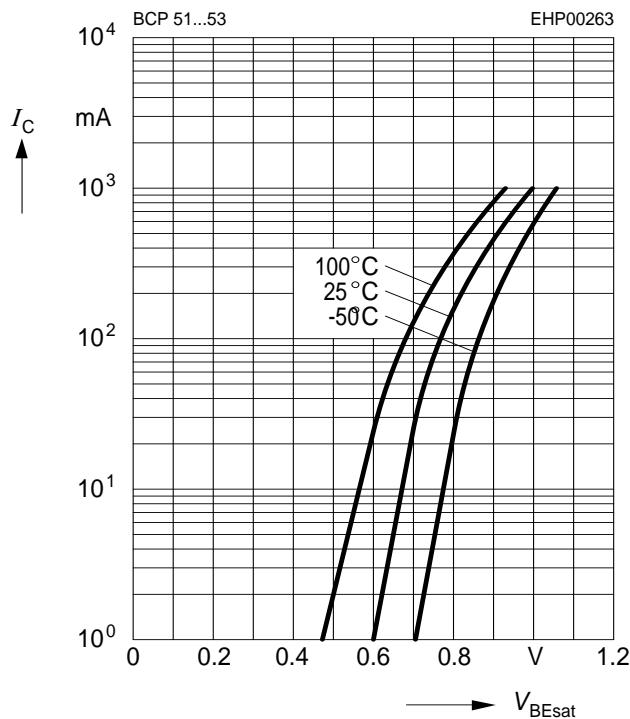
DC current gain $h_{FE} = f(I_C)$

$V_{CE} = 2 \text{ V}$



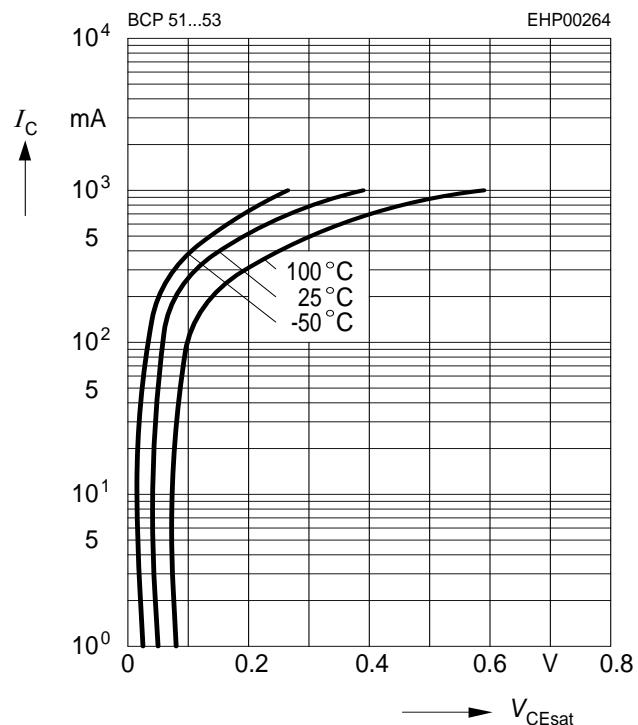
Base-emitter saturation voltage

$I_C = f(V_{BEsat}), h_{FE} = 10$



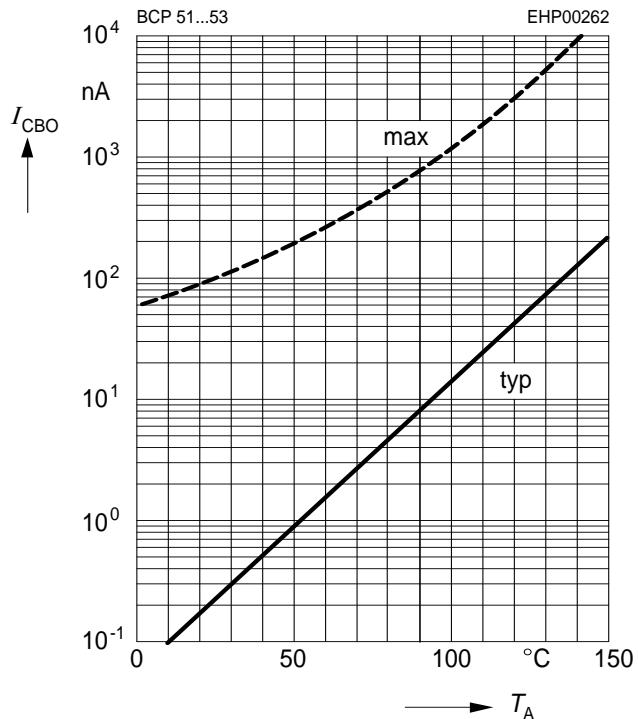
Collector-emitter saturation voltage

$I_C = f(V_{CEsat}), h_{FE} = 10$

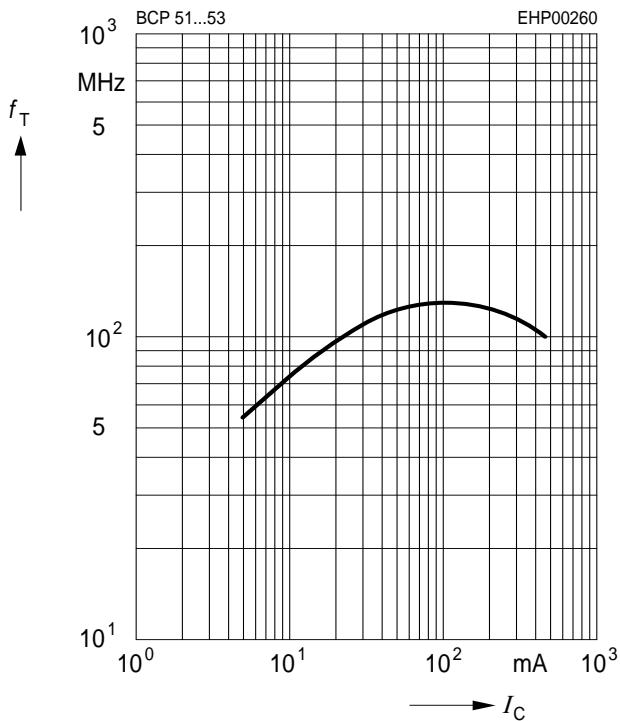


Collector cutoff current $I_{CBO} = f(T_A)$

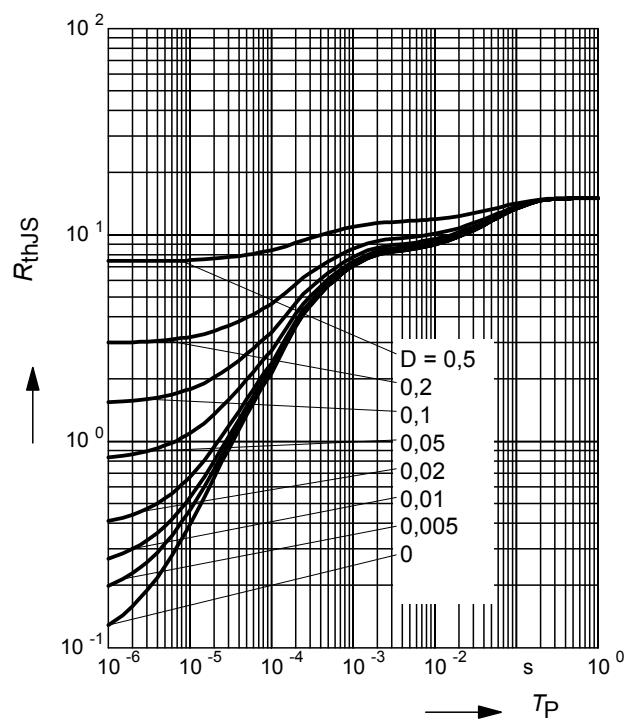
$V_{CBO} = 30 \text{ V}$



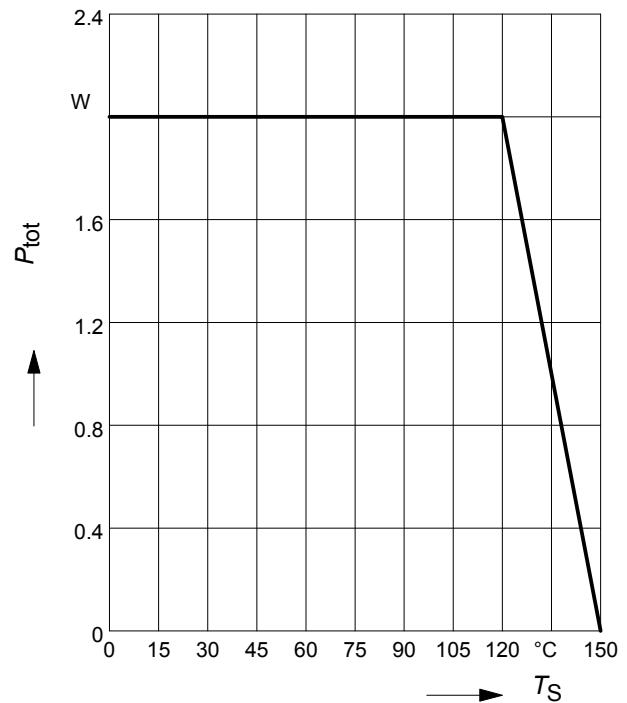
Transition frequency $f_T = f(I_C)$
 $V_{CE} = 10 \text{ V}$



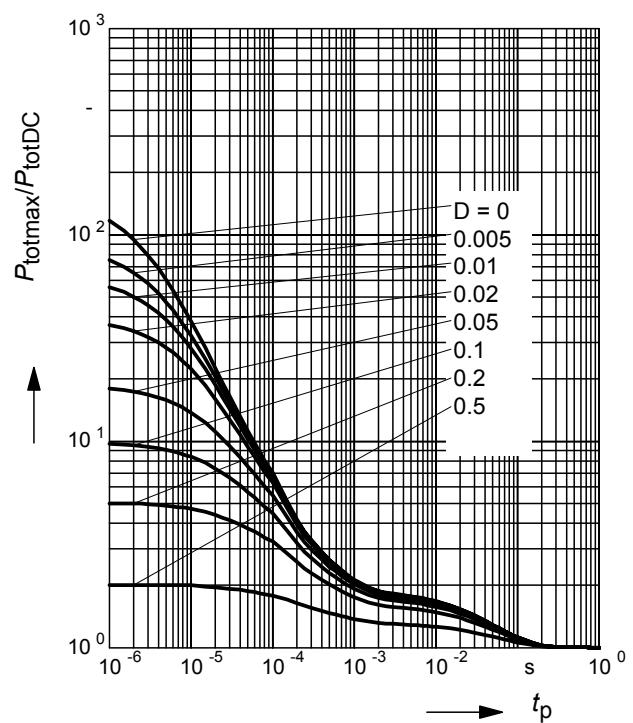
Permissible Pulse Load $R_{thJS} = f(t_p)$



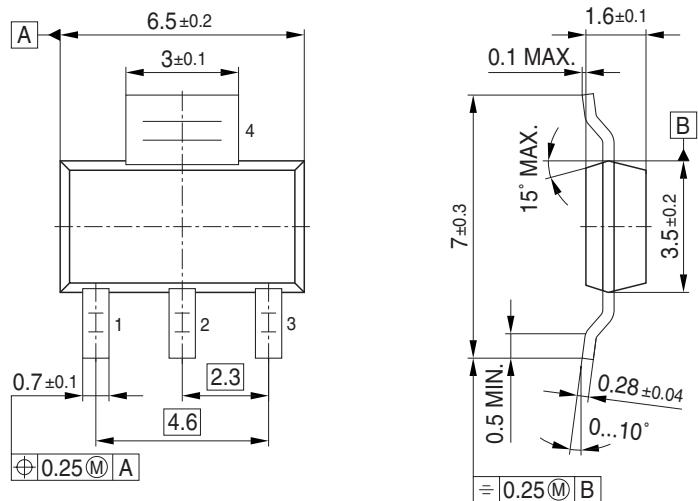
Total power dissipation $P_{tot} = f(T_S)$



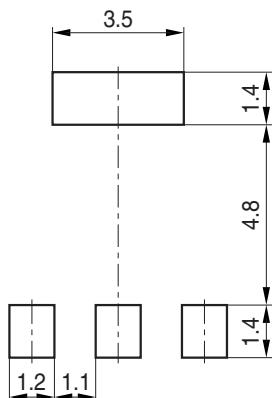
Permissible Pulse Load
 $P_{totmax}/P_{totDC} = f(t_p)$



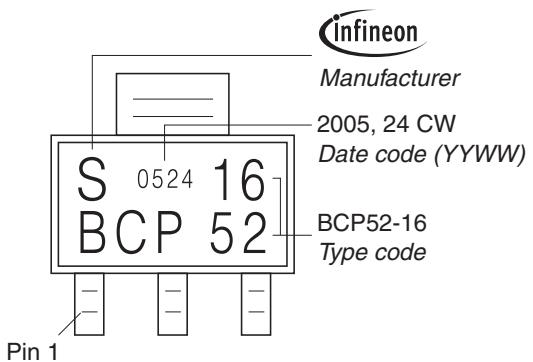
Package Outline



Foot Print

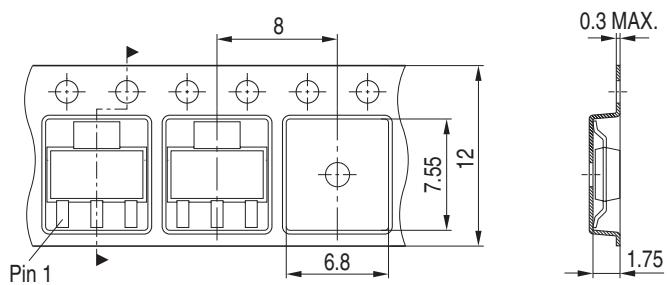


Marking Layout (Example)



Packing

Reel ø180 mm = 1.000 Pieces/Reel
Reel ø330 mm = 4.000 Pieces/Reel



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